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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO	
10/002,855	11/30/2001	Anne E. Miller	042390.P12072	3668	
	90 08/06/2003				
Mark V. Seeley BLAKELY, SOFOLOFF, TAYLOR & ZAFMAN Seventh Floor 12400 Wilshire Bouleyard			EXAMINER		
			UMEZ ERONINI, LYNETTE T		
Los Angeles, C.			ART UNIT PAPER NUMBER		
	•		1765	2	
		DATE MAILED: 08/06/2003	7		

Please find below and/or attached an Office communication concerning this application or proceeding.

,	£ .	Application No.	Applicant(s)	me
. Office Action Summary		10/002,855	MILLER, ANNE E.	
		Examiner	Art Unit	
		Lynette T. Umez-Eronini	1765	
Period f	The MAILING DATE of this communication app for Reply	pears on the cover sheet with th	e correspondence address	s
- External control con	HORTENED STATUTORY PERIOD FOR REPL' MAILING DATE OF THIS COMMUNICATION. ensions of time may be available under the provisions of 37 CFR 1.13 or SIX (6) MONTHS from the mailing date of this communication. e period for reply specified above is less than thirty (30) days, a reply o period for reply is specified above, the maximum statutory period ure to reply within the set or extended period for reply will, by statute, reply received by the Office later than three months after the mailing led patent term adjustment. See 37 CFR 1.704(b).	36(a). In no event, however, may a reply be within the statutory minimum of thirty (30) of will apply and will expire SIX (6) MONTHS from	timely filed lays will be considered timely. om the mailing date of this commun	ication.
1)	Responsive to communication(s) filed on	·		
2a)□	This action is FINAL. 2b)⊠ Thi	s action is non-final.		
3) Dispositi	Since this application is in condition for allowa closed in accordance with the practice under <i>l</i> ion of Claims	nce except for formal matters, Ex <i>parte Quayle</i> , 1935 C.D. 11,	prosecution as to the me 453 O.G. 213.	rits is
4) 🖾	Claim(s) 15-23 is/are pending in the application	n.		
	4a) Of the above claim(s) is/are withdraw	n from consideration.		
	Claim(s) is/are allowed.			
6)⊠	Claim(s) 15-23 is/are rejected.			
7)	Claim(s) is/are objected to.			
8)[	Claim(s) are subject to restriction and/or	election requirement.		
Application	on Papers			
	The specification is objected to by the Examiner.			
10)□ 1	The drawing(s) filed on is/are: a)☐ accept	ed or b)☐ objected to by the Exa	aminer.	
	Applicant may not request that any objection to the	drawing(s) be held in abevance.	See 37 CFR 1 85(a)	
11)∐ ⊺	ne proposed drawing correction filed oni	is: a)⊡ approved b)⊡ disappr	oved by the Examiner.	
	If approved, corrected drawings are required in reply	y to this Office action.		
	he oath or declaration is objected to by the Exa	miner.		
	nder 35 U.S.C. §§ 119 and 120			
13) 🗌 📝	Acknowledgment is made of a claim for foreign p	priority under 35 U.S.C. § 119(a	a)-(d) or (f).	
a)[	] All b) ☐ Some * c) ☐ None of:		, , , , , , , , , , , , , , , , , , ,	
•	<ol> <li>Certified copies of the priority documents I</li> </ol>	have been received.		
2	2. Certified copies of the priority documents I	have been received in Applicati	ion No.	
	B. ☐ Copies of the certified copies of the priority application from the International Burese the attached detailed Office action for a list of	y documents have been receive	ed in this National Stage	
14) 🗌 Ac	cknowledgment is made of a claim for domestic	priority under 35 U.S.C. & 1197	ou.	-4.
a)	☐ The translation of the foreign language proviscknowledgment is made of a claim for domestic	sional application has been rec	eived	ation).
Attachment(s	s)	,	and/or (Z),	
2)  Notice ( 3)  Informa	of References Cited (PTO-892) of Draftsperson's Patent Drawing Review (PTO-948) tion Disclosure Statement(s) (PTO-1449) Paper No(s)	5) Notice of Information	(PTO-413) Paper No(s) Patent Application (PTO-152)	_·
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## **DETAILED ACTION**

## Claim Rejections - 35 USC § 102

- 1. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:
  - (b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.
- 2. Claims 15, 17, and 18 are rejected under 35 U.S.C. 102(b) as being anticipated by Watts et al. (US 5,897,375).

Watts teaches, "In particular, the slurry taught herein contains an oxidizing agent (e.g., hydrogen peroxide H<sub>2</sub>O<sub>2</sub>), a citrate salt (e.g., ammonium citrate or potassium citrate), an abrasive slurry (e.g., alumna abrasive or silica abrasive), and a balance of a solvent such as deionized water or an alcohol. In addition, the compound 1,2, 4-triazole or a triazole derivative such as benzotriazole (same as applicant's corrosion inhibitor) can be included within the slurry to improve copper polishing planarity" (column 2, lines 27-37). "In general, the oxidizing agent (H<sub>2</sub>O<sub>2</sub>) of the slurry 24 may be within any range of roughly 0.2 weight percent (wt %). The carboxylate salt or citrate salt can be within a range of roughly 0.2 weight percent to roughly 20 weight percent. The abrasive slurry (alumna abrasive) is roughly 1.0 weight percent to 12.0 weight percent of the slurry 24" (column 5, lines 7-13). It is noted that Watts further teaches, "A typical abrasive which has been experimentally shown to result in good copper removal and planarization is an alumina abrasive, but a silica abrasive in lieu of the alumina abrasive or in addition with alumina may be used" (column 4, lines 61-65),

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which provides evidence that silica can be substituted for alumina. "In addition, an optional triazole or triazole derivative can be provided within the slurry **24** to be roughly 0.05 weight percent to 2.0 weight percent of the slurry **24**. A remaining balance of the slurry . . . is typically deionized water . . ." (column 5, lines 13-17). Hence the above reads on:

A slurry for polishing comprising a mixture of:

between about 0.01 mole and about 0.1 mole per liter of a citric acid salt;

between about 1% and 20% by volume of a silica based abrasive;

between about 0.0004 and about 2 moles per liter of an oxidizer; and

water solvent, **as in claim 15**. Since Watts' polishing composition is the same as that of applicant's polishing mixture, then using Watts' polishing composition in the same manner as the claimed invention would inherently result in a slurry for polishing a barrier layer as **in claim 15**.

The above aforementioned further reads on,

between 0.001 mole and about 0.05 mole per liter of a corrosion inhibitor, in claim 17;

the corrosion inhibitor that is selected from the group consisting of benzotriazole, in claim 18.

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## Claim Rejections - 35 USC § 103

- 3. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
  - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 4. Claims 16, 19, and 20 are rejected under 35 U.S.C. 103(a) as being unpatentable over Watts (US '375) as applied to claim 15 above, and further in view of Kaufman et al. (US 5,954,997).

Watts differs in failing to specify the slurry wherein the mixture has a pH that is greater than about 7.0, in claim 16.

Kaufman teaches, "It is desirable to maintain the pH of the CMP slurry of this invention within a range of from about 2.0 to about 12.0, and preferably between form about 4.0 and 9.0 in order to facilitate control of the CMP process" (column 8, lines 22-25).

It is the examiner's position that it would have been obvious to one having ordinary skill in the art at the time of the claimed invention to modify Watts by maintaining a cmp slurry that has a pH greater than 7.0 as taught by Kaufman for the purpose of facilitating control of the CMP process (Kaufman, column 8, lines 22-25).

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Watts differs in failing to teach the slurry comprising less than 0.1 wt % of a surfactant, in claim 19; and a surfactant that is selected from the group as recited in claim 20.

Kaufman's slurry further includes a variety of optional additives such as surfactants that stabilize the dispersion of abrasive in the slurry against settling, flocculation, and decomposition (column 6, lines 32-37) and ranges from 0.001 and 2% by weight (column 6, lines 55-58), which provides evidence that a slurry comprises less than 0.1 wt % of a surfactant, as claimed in the present invention.

It is the examiner's position that it would have been obvious to one having ordinary skill in the art at the time of the claimed invention to modify Watts by employing a slurry that comprises a surfactant, as taught by Kaufman for the purpose of promoting stabilization of a CMP slurry against settling, flocculation, and decomposition (Kaufman, column 6, lines 34-36).

5. Claim 21 is rejected under 35 U.S.C. 103(a) as being unpatentable over Watts (US '375) as applied to claim 15 above, and further in view of Payne (US 4,752,628).

Watts differs in failing to teach the slurry further comprising less than about 300 ppm of the biocide.

Payne teaches a lapping composition that is made up of 0.05 - 3 % (~ 500 ppm – 30,000 ppm) by weight biocide (column 1, lines 22-24 and 30, and 51-60), which provides evidence that the concentration of biocide in a slurry varies and is a so-called "result effective variable."

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It is the examiner's position that it would have been obvious to one having ordinary skill in the art at the time of the claimed invention to modify Watts by varying the concentration of a biocide in a lapping (polishing) composition as taught by Payne, since it has been disclosed that discovering an optimum value of a result effective variable involves only routine skill in the art. In re Boesch, 617 F.2d 272, 205 USPQ 215 (CCPA 1980) and for the purpose of preparing a slurry that remain stable upon storage and shipment to the end user from a manufacturer or formulator (Payne, column 2, lines 44-46).

6. Claim 22 is rejected under 35 U.S.C. 103(a) as being unpatentable over Watts (US '375) view of Li et al. (US 6,242,351 B1).

Watts teaches, "In particular, the slurry taught herein contains an oxidizing agent (e.g., hydrogen peroxide  $H_2O_2$ ), a citrate salt (e.g., ammonium citrate or potassium citrate), an abrasive slurry (e.g., alumna abrasive or silica abrasive), and a balance of a solvent such as deionized water or an alcohol. In addition, the compound 1,2, 4-triazole or a triazole derivative such as benzotriazole (same as applicant's corrosion inhibitor) can be included within the slurry to improve copper polishing planarity" (column 2, lines 27-37). "In general, the oxidizing agent ( $H_2O_2$ ) of the slurry 24 may be within any range of roughly 0.2 weight percent (wt %) to 5.0 weight percent (wt %). The carboxylate salt or citrate salt can be within a range of roughly 0.2 weight percent to roughly 20 weight percent. The abrasive slurry (alumna abrasive) is roughly 1.0 weight percent to 12.0 weight percent of the slurry 24" (column 5, lines 7-13). It is noted that Watts further

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teaches, "A typical abrasive which has been experimentally shown to result in good copper removal and planarization is an alumina abrasive, but a silica abrasive in lieu of the alumina abrasive or in addition with alumina may be used" (column 4, lines 61-65), which provides evidence that silica can be substituted for alumina. "In addition, an optional triazole or triazole derivative can be provided within the slurry 24 to be roughly 0.05 weight percent to 2.0 weight percent of the slurry 24. A remaining balance of the slurry . . . is typically deionized water . . ." (column 5, lines 13-17). Hence the above reads on:

A slurry for polishing comprising a mixture of:

between about 0.01 mole and about 0.1 mole per liter of a citric acid salt; between about 1% and 20% by volume of a silica based abrasive; and water solvent.

Watts differs in failing to teach a slurry comprising .38 grams per liter of a 30%  $H_2O_2$  solution.

Li teaches, " . . . a . . . slurry from (i) between about 0 and 7 wt-% oxidizer" (column 2, lines 22-26). "Suitable oxidizers include, for example, hydrogen peroxide, . . ." (column 3, lines 55-57), which encompasses 0.38 g/l ( $\sim$ 0.038 g/100 ml  $\sim$  0.038 wt percent)  $H_2O_2$ , shows varying concentrations of peroxide, and provides evidence that the concentration of a so-called "result effective variable."

It is the examiner's position that it would have been obvious to one having ordinary skill in the art at the time of the claimed invention to modify Watts by using Li's concentration of hydrogen peroxide since it has been disclosed that discovering an

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optimum value of a result effective variable involves only routine skill in the art. In re Boesch, 617 F.2d, 272, 205 USPQ 215 (CCPA 1980).

7. Claim 23 is rejected under 35 U.S.C. 103(a) as being unpatentable over Watts (US '375) in view of Li (US '351 B1) as applied to claim 22 above, and further in view of Kaufman (US '997).

Watts in view of Li differs in failing to specify the slurry wherein the mixture has a pH that is greater than about 7.0, in claim 23.

Kaufman teaches, "It is desirable to maintain the pH of the CMP slurry of this invention within a range of from about 2.0 to about 12.0, and preferably between from about 4.0 and 9.0 in order to facilitate control of the CMP process" (column 8, lines 22-25).

It is the examiner's position that it would have been obvious to one having ordinary skill in the art at the time of the claimed invention to modify Watts in view of Li by maintaining a cmp slurry that has a pH greater than 7.0 as taught by Kaufman for the purpose of facilitating control of the CMP process (Kaufman, column 8, lines 22-25).

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Lynette T. Umez-Eronini whose telephone number is 703-306-9074. The examiner is normally unavailable on the First Friday.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Nadine Norton can be reached on 703-305-2667. The fax phone numbers

Lynette J. Umez-Eunini

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for the organization where this application or proceeding is assigned are 703-872-9310 for regular communications and 703-872-9311 for After Final communications.

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August 4, 2003